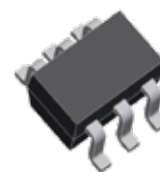


FEATURES

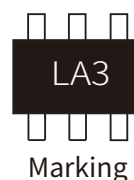
- | 150W Peak Pulse Power ($t_p=8/20\mu s$)
- | Protects Four Bidirectional I/O Lines
- | Working voltages : 3.3 V
- | Low Clamping Voltage

APPLICATIONS

- | Cellular Handsets and Accessories
- | Cordless Phones
- | I²C Bus Protection
- | Portable instrumentation
- | Personal Digital Assistant (PDA)
- | Microcontroller Input Protection



SOT-23-6L



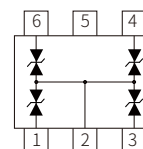
Marking

IEC COMPATIBILITY

- | IEC61000-4-2 (ESD) $\pm 30kV$ (air), $\pm 30kV$ (contact)
- | IEC61000-4-4 (EFT) 40A (5/50ns)

APPROVALS

- | | |
|-------------|------------------------------------|
| RoHS | Compliance with 2011/65/EU |
| HF | Compliance with IEC61249-2-21:2003 |



Schematic Symbol

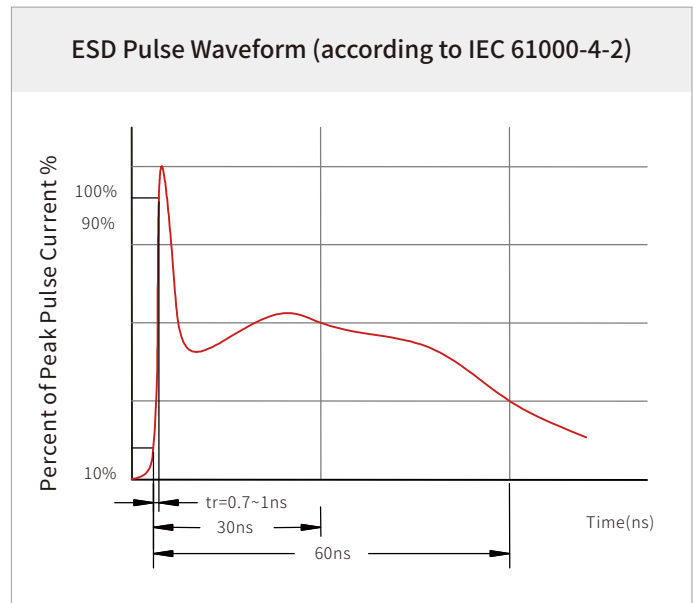
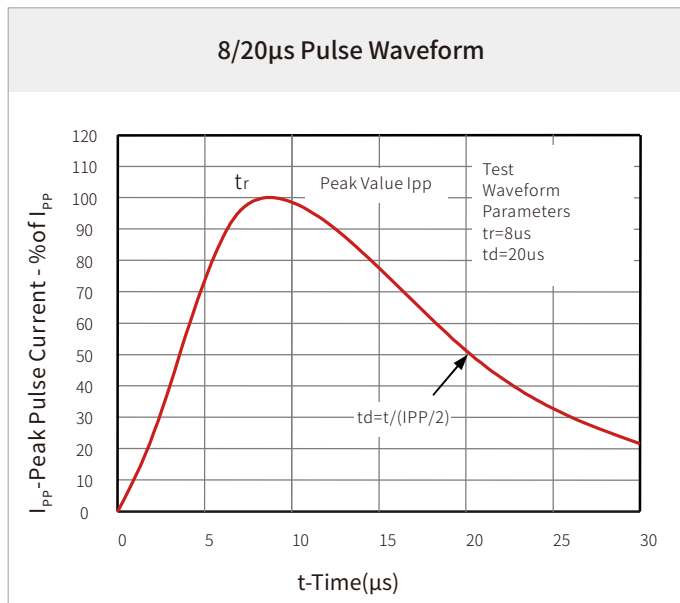
THERMAL CONSIDERATIONS

Symbol	Parameter	Value	Unit
P_{pp}	Peak Pulse Power ($t_p=8/20\mu s$ waveform)	150	Watts
T_J	Operating Temperature Range	-55 to +125	°C
T_{STG}	Storage Temperature Range	-55 to +150	°C

ELECTRICAL CHARACTERISTICS

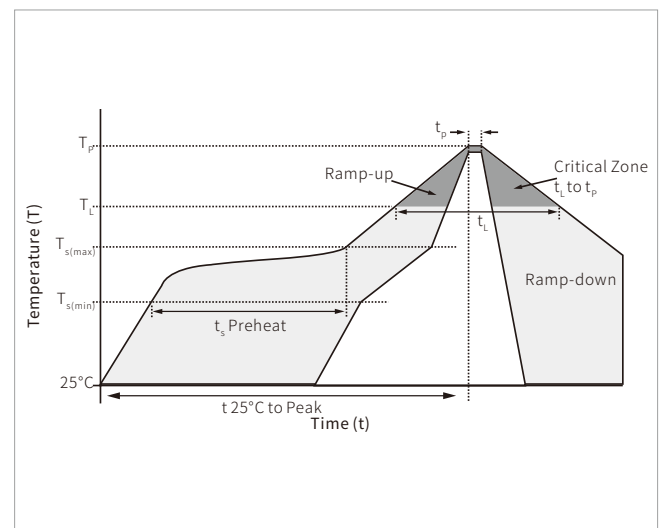
Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V_{RWM}	Reverse Stand-off Voltage				3.3	V
V_{BR}	Reverse Breakdown Voltage	$I_T=1mA$	3.8			V
I_R	Reverse Leakage Current	$V_{RWM}=3.3V$			0.1	μA
V_C	Clamping Voltage	$I_{pp}=1A, t_p=8/20\mu s$			6	V
V_C	Clamping Voltage	$I_{pp}=13A, t_p=8/20\mu s$			10.5	V
I_{PP}	Peak Pulse Current	$t_p=8/20\mu s$			13	A
C_J	Off State Junction Capacitance	$V_R=0V, f=1MHz$ I/O-GND		15		pF

CHARACTERISTIC CURVES

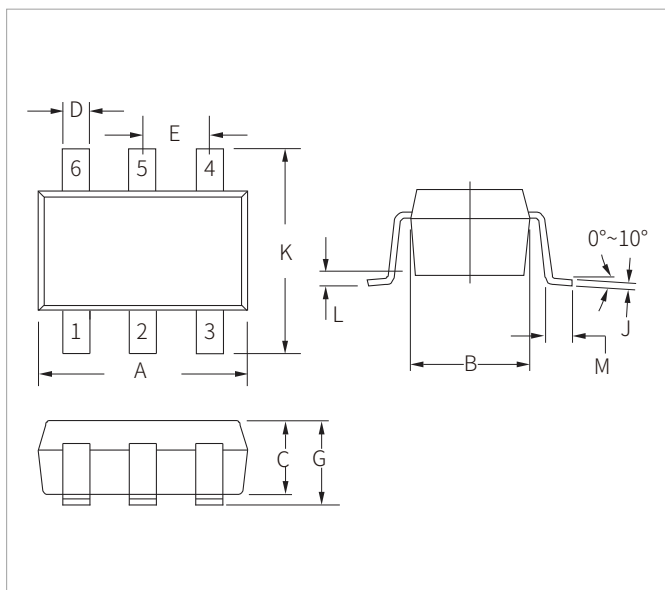


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Time (min to max) (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260°C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C

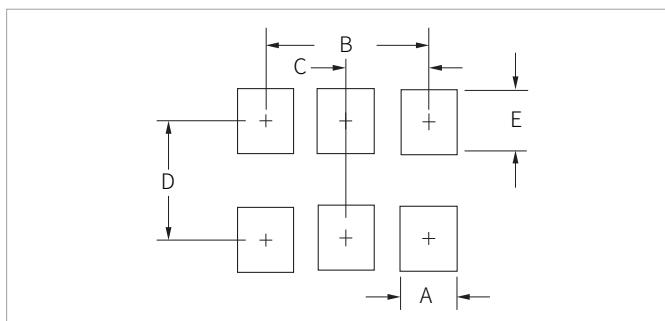


SOT-23-6L PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.80	3.10	0.110	0.125
B	1.50	1.80	0.059	0.071
C	0.90	1.30	0.036	0.051
D	0.25	0.50	0.010	0.020
E	0.85	1.05	0.033	0.040
G	0.90	1.45	0.036	0.057
J	0.09	0.20	0.003	0.008
K	2.60	3.00	0.102	0.118
L	0.0	0.15	0.0	0.006
M	0.30	0.60	0.012	0.024

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters	Inches
	Nominal	Nominal
A	0.70	0.028
B	1.90	0.074
C	0.95	0.037
D	2.40	0.094
E	1.00	0.039

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
SE26T15B3.3E	SOT-23-6L	3000PCS	7"

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By QR Code

Website



Wechat

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